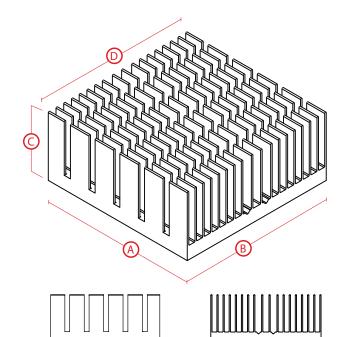


# High Performance BGA Cooling Solutions w/ Thermal Tape Attachment

# ATS PART # ATS-55330K-C2-R0

#### **Features & Benefits**

- » High efficiency cross-cut fin design provides low pressure drop characteristics
- » Large surface area increases heat sink performance
- » Designed for BGAs and surface mount packages
- » Comes preassembled with high performance thermal interface material



## **Thermal Performance**

Thermal Per	formance	*Image above is for illustration purposes only.		
AIR VELOCITY		THERMAL RESISTANCE		
FT/MIN	M/S	°C/W (UNDUCTED FLOW)	°C/W (DUCTED FLOW)	
200	1.0	6.4	NA	
300	1.5	NA		
400	2.0	NA		
500	2.5	NA		
600	3.0	NA		
700	3.5	NA		
800	4.0	NA		

### **Product Details**

DIMENSION A	DIMENSION B	DIMENSION C	DIMENSION D	INTERFACE MATERIAL	FINISH
33 mm	33 mm	14.5 mm	33 mm	SAINT-GOBAIN C675	BLACK-ANODIZED

#### **NOTES:**

1) Dimension C = heat sink height from bottom of the base to the top of the fin field.

2) Thermal performance data are provided for reference only. Actual performance may vary by application.

 ATS reserves the right to update or change its products without notice to improve the design or performance.

4) Contact ATS to learn about custom options available.



For more information, to find a distributor or to place an order, visit www.qats.com or call: 781.769.2800 (North America); +31 (0) 3569 84715 (Europe).